

HAT2160H Silicon N Channel Power MOS FET

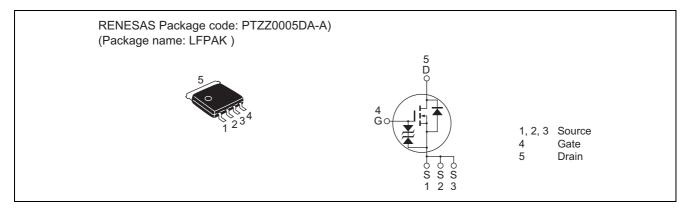
Power Switching

REJ03G0002-0300 Rev.3.00 Sep 26, 2005

Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
- $R_{DS(on)} = 2.1 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	20	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	60	A
Drain peak current	I _{D(pulse)} Note1	240	A
Body-drain diode reverse drain current	I _{DR}	60	A
Avalanche current	I _{AP} Note 3	30	A
Avalanche energy	E _{AR} Note 3	90	mJ
Channel dissipation	Pch Note2	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 $\mu s,\,duty\,cycle \leq$ 1%

2. $Tc = 25^{\circ}C$

3. Value at Tch = 25°C, Rg \geq 50 Ω

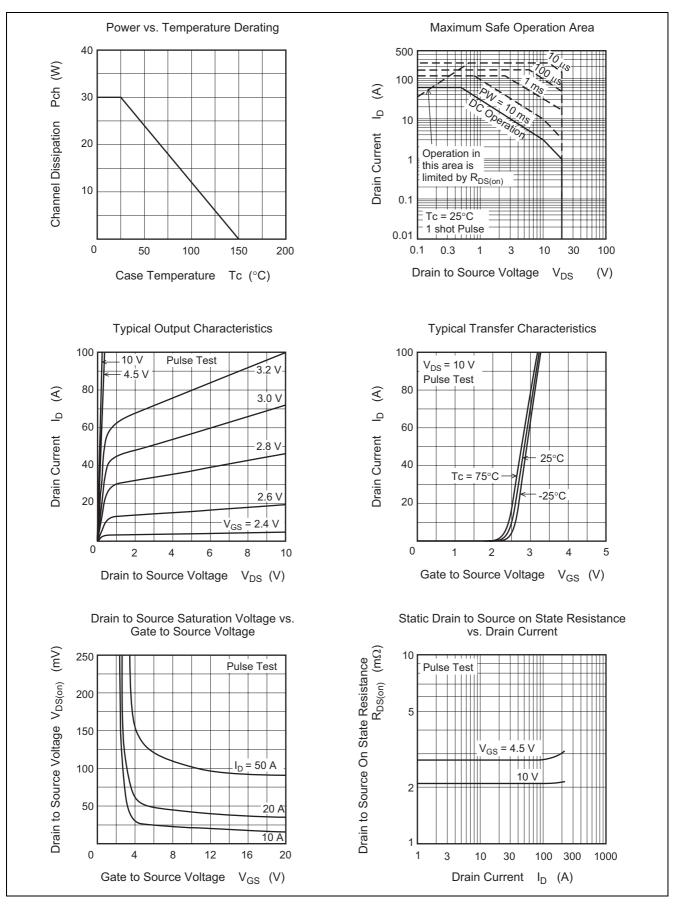
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	20	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, \text{ V}_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 20 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	0.8	_	2.3	V	V _{DS} = 10 V, I _D = 1 mA
Static drain to source on state	R _{DS(on)}	_	2.1	2.6	mΩ	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	2.8	4.1	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	78	130	_	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	7750	_	pF	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz
Output capacitance	Coss	_	1220	_	pF	
Reverse transfer capacitance	Crss		450		pF	
Gate resistance	Rg		0.5		Ω	
Total gate charge	Qg		54		nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$ $I_{D} = 60 \text{ A}$
Gate to source charge	Qgs		19		nC	
Gate to drain charge	Qgd		14		nC	
Turn-on delay time	t _{d(on)}		17		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A},$
Rise time	tr		60		ns	$V_{\text{DD}} \cong 10 \text{ V}, \text{ R}_{\text{L}} = 0.33 \Omega,$ Rg = 4.7 Ω
Turn-off delay time	t _{d(off)}		65		ns	
Fall time	t _f	_	15	_	ns	
Body-drain diode forward voltage	V _{DF}	_	0.82	1.07	V	$IF = 60 A, V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery	t _{rr}	_	40		ns	$IF = 60 A, V_{GS} = 0$
time						di⊧/ dt = 100 A/ µs

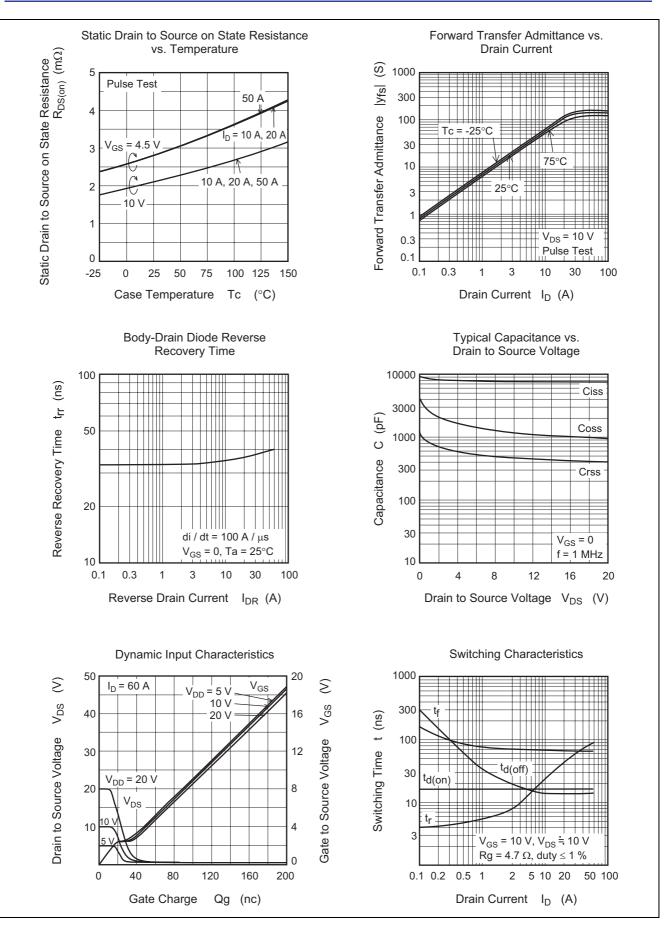
Notes: 4. Pulse test



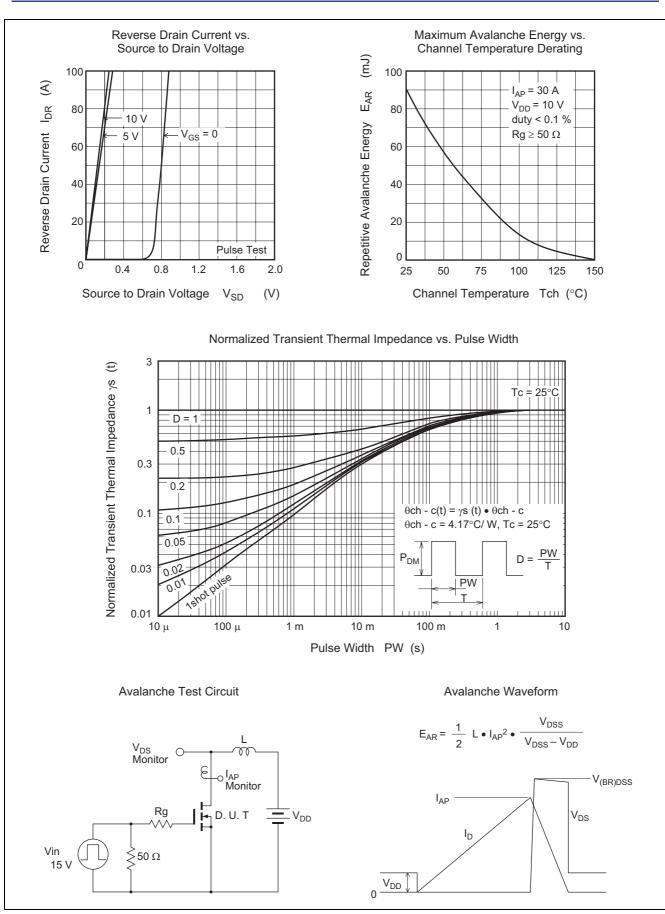
Main Characteristics



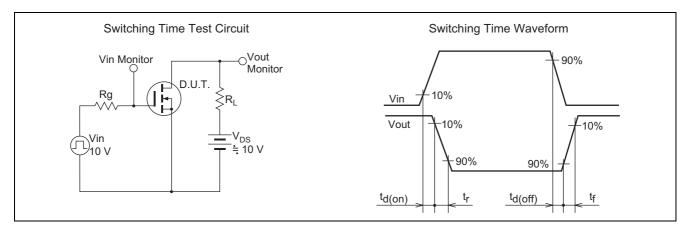






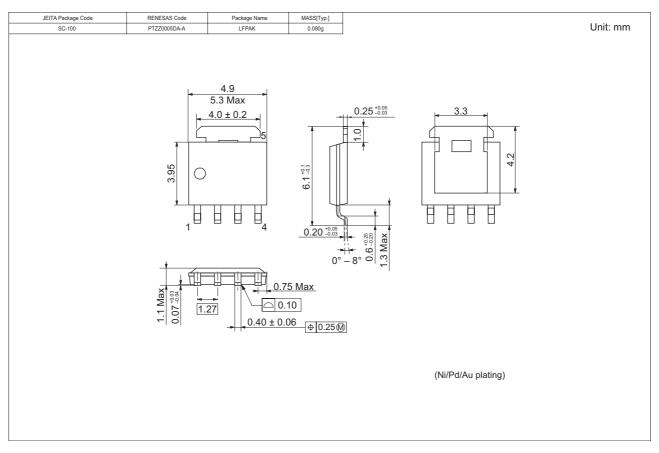








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2160H-EL-E	2500 pcs	Taping

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